

SMD Transient Voltage Suppressors

APPROVAL SHEET

Customer Information

Customer:			
Part Name :			
Part No. :			
Model No. :			
COMPAN	ΙΥ	PURCHASE	R&D

Vendor Information

Name:	SFI ELECTRONICS TECHNOLOGY CORP. INC.
Part Name	Chip TVS
Part No.	0603ML C Series
Lot No.	

SFI ELECTRONICS TECHNOLOGY INC.

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Quality Control	Document Control	Business Issue					
	REV : C	Prepared	Check				
DIN EN ISO 9001 Certificate: 01 100 008833	94. 5. 20						



SMD Transient Voltage Suppressors

PART NO. SFI 0603ML C Series

1.1Performance Characteristics

App.	Part Number	Work	_	Breakdown	Clamping	Peak	Energy	Capacitance
Item		Volta	age	Voltage _(*1)	Voltage	Current		
	Symbol	AC	DC	V (1mA)	$V_{(*2)}$	$A_{(*3)}$	J	pF _(*1)
	0603ML050C	2.5	3.3	5(4.0~6.0)	<12	>30	>0.1	1250
	0603ML080C	4	5.5	8(6.4~9.6)	<20	>30	>0.1	800
	0603ML120C	6	9	12(10.2~13.8)	<24	>30	>0.1	680
	0603ML150C	8	11	15(12.75~17.25)	<28	>30	>0.1	460
	0603ML180C	11	14	18(15.3~20.7)	<35	>30	>0.1	350
	0603ML220C	12	16.5	22(19.8~24.2)	<40	>30	>0.1	300
	0603ML240C	14	18	24(21.6~26.4)	<45	>30	>0.1	270
	0603ML270C	17	22	27(24.3~29.7)	< 50	>30	>0.1	235
	0603ML330C	20	26	33(29.7~36.3)	<60	>30	>0.1	200
	0603ML390C	25	30	39(35.1~42.9)	<72	>30	>0.1	120
	0603ML470C	30	38	47(42.3~51.7)	<85	>30	>0.1	100
	0603ML560C	35	45	56(51.52~60.48)	< 100	>30	>0.1	80

- * 1 The varistor voltage was measured at 1 mA current, tolerance at 5~8V(+-20%), 12~18V(+-15%), exceed 22V (+-10%)
- * 2 The Clamping voltage was measured at standard current, tolerance at 5~8V(+-20%) · 12~18V(+-15%) · exceed 22V (+-10%)
- * 3 The Peak Current was tested at 8/20 us waveform
- $\,*\,$ 4 The capacitance value and Energy only for customer reference $\,\,$, it's not formal specification

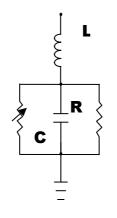
EQUIVALENT CIRCUIT

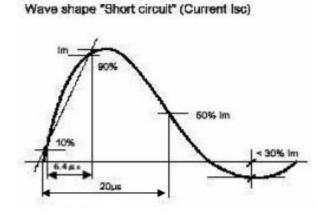
☆L Body Inductance

☆C Device Capacitance

☆Rv Voltage Variable Resistor

☆R Insulation Resistor





8/20 μ s waveform current (A)

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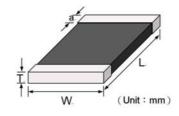
1.2 Reference Data	Symbol	Value	Unit
Maximum Energy Absorption *5	E <	0.1	J
Response time	T _{rise} <	1	ns
Leakage current at V _{1mA} ×80%	I _{V v} <	5	uA
Leakage current at V _{1mA} ×80% (After reality Test)	I _{VVA} <	200	uA
Operation ambient temperature		- 55∼ + 85	$^{\circ}\!\mathbb{C}$
Storage temperature		-55∼+125	$^{\circ}\!\mathbb{C}$
Reflow solder profile temperature(Recommend)		250	$^{\circ}$ C

[%]5.Testing condition :8×20 μ s waveform.

1.3 Other Data	Symbol	Value	Unit
Body		ZnO	
End termination		Ag/NI/Sn	
Packaging		Reel	
Marking		None	
Lead content	<	1000	ppm

2 .Size

Model	0603(1608) Series
Length(L)	1.6 ±0.15mm
Width(W)	0.80 ±0.1mm
Thickness(T)	0.9 mm Max
Termination(a)	0.25 ±0.1 mm



3. Environmental Reliability Test

Characteristic	Test method and description					
High Temperature Storage	The specimen shall be subjected to $150 \pm 2^{\circ}$ C for 1000 ± 12 hours in a thermostatic bath without load and then stored at room temperature and humidity for 1 to 2 hours. The change of varistor voltage shall be within 10 %.					
	The temperature cycle of specified temperature shall be repeated five times and		Temperature	Period		
Temperature Cycle	then stored at room temperature and	1	-40±3℃	30Min±3		
	humidity for one or two hours. The change	2	Room Temperature	1~2 hours		
	of varistor voltage shall be within 10 % and mechanical damage shall be examined.		125±2℃	30Min±3		
			Room Temperature	1~2 hours		
High Temperature Load	After being continuously applied the maximum allowable voltage at $85 \pm 2^{\circ}$ C for 1000 ± 2 hours, the specimen shall be stored at room temperature and humidity for one or two hours, the change of varistor voltage shall be within 10%.					
Damp Heat Load/ Humidity Load	The specimen should be subjected to $40 \pm 2^{\circ}\text{C}$, 90 to 95 % RH environment, and the maximum allowable voltage applied for 1000 hours, then stored at room temperature and humidity for one or two hours. The change of varistor voltage shall be within 10%					
Low Temperature Storage	The specimen should be subjected to $40 \pm 2^{\circ}$ 0 stored at room temperature for one or two how be within 10 %					



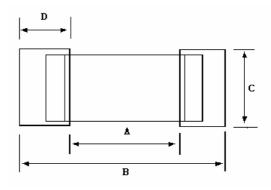
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4. Soldering Recommendations

4.1 Recommended solder pad layout

(Unit: mm)

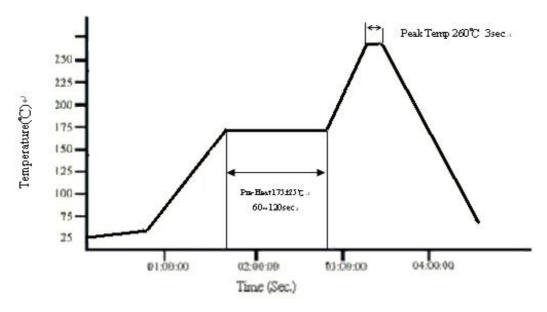
	Α	В	С	D
0402	0.4~0.6	1.4~1.8	0.5~0.6	0.6~1.2
0603	0.8~1.2	2.2~2.8	0.6~1.0	0.9~1.5
0805	1.0~1.5	2.6~3.2	1.2~1.5	1.1~1.8
1206	1.8~2.5	4.2~5.2	1.2~1.8	1.2~1.8
1210	1.8~2.5	4.2~5.2	2.2~3.0	1.3~2.0
1812	2.5~3.3	5.5~6.7	2.8~3.6	1.3~2.2
2220	3.8~4.6	6.6~7.8	4.8~5.5	1.3~2.2



- 4.2 The SIR test of the solder paste shall be done (Based on JIS-Z-3284)
- 4.3 Steel plate and foot distance printing

Foot distance printing (mm)	Steel Plate thickness (mm)
> 0.65mm	0.18mm
0.65mm~0.5mm	0.15mm
0.50mm~0.40mm	0.12mm
<=0.40 mm	0.10mm

4.4 The IR reflow and temperature of Soldering for Pb Free



☆ IR reflow Pb Free Process suggestion profile

- (1) The solder recommend is Sn96.5/Ag 3.5 of 120 to 150 $\mu\,\mathrm{m}$
- (2) Ramp-up rate (217°C to Peak) + 3°C/second max
- (3) Temp. maintain at 175 +/-25°C 180 seconds max
- (4) Temp. maintain above 217 $\,^{\circ}\mathrm{C}\,$ 60-150 seconds

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SFI

SFI Electronics Technology

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- (5) Peak temperature range 245° +20°C/-10 °C time within 5 °C of actually peak temperature (tp) 10~20 seconds
- (6) Ramp down rate +6 °C/second max.

*Perform adequate test in advance as the reflow temperature profile will vary according to the conditions of the manufacturing process, and the specification of the reflow furnace.

4.5 Hand Soldering

In hand soldering of the Varistors. Large temperature gradient between preheated the Varistors and the tip of soldering iron may cause electrical failures and mechanical damages such as crackings or breakings of the devices. The soldering shall be carefully controlled and carried out so that the temperature gradient is kept minimum with following recommended conditions for hand soldering.

- 4.5.1 Recommended Soldering Condition 1
 - (1) Solder:
 - **0.12~0.18mm** Thread solder (Sn96.5:Ag3.5) with soldering flux in the core. Rosin-based and non-activated flux is recommended.
 - (2) Preheating
 - The Varistors shall be preheated so that Temperature Gradient between the devices and the tip of soldering iron is 150° C or below.
 - (3) Soldering Iron
 - Rated Power of 20w max with 3mm soldering tip in diameter. Temperature of soldering iron tip 300° C max (The required amount of solder shall be melted in advance on the soldering tip.)
 - (4) Cooling

After soldering. The Varistors shall be cooled gradually at room ambient temperature.

- 4.5.2 Recommended Soldering Condition 2 (Without preheating)
 - (1) Solder iron tip shall not directly touch to ceramic dielectrics.
 - (2) Solder iron tip shall be fully preheated before soldering while soldering iron tip to the external electrode of Varistors.

4.6 Post Soldering Cleaning

- 4.6.1 Residues of corrosive soldering fluxes on the PC board after cleaning may greatly have influences on the electrical characteristic and the reliability (such as humidity resistance)of the Varistors which have been mounted on the board. It shall be confirmed that the characteristic and the reliability of the devices are not affected by the applied cleaning conditions.
- 4.6.2. When an ultrasonic cleaning is applied to the mounted Varistors on PC Boards. Following conditions are recommended for preventing failures or damages of the devices due to the large vibration energy and the resonance caused by the ultrasonic waves.
 - (1) Frequency 29MHz max
 - (2) Radiated Power 20w/lithr max
 - (3) Period 5minuets max

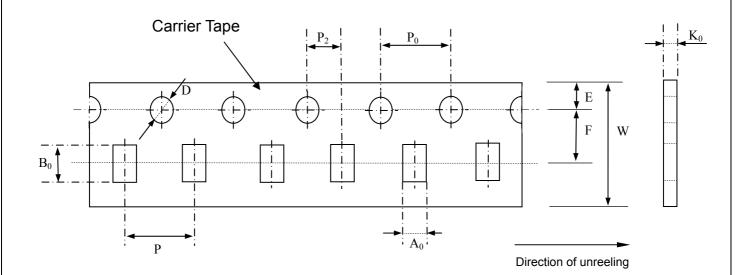
Part No.:	SFI 060	3ML C Series	Doc	ument No.	AS-RI	00603_C_Series	REV.	С
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5. Packaging Specification

- 5.1 Carrier tape and transparent cover tape should be heat-sealed to carry the products, and the reel should be used to reel the carrier tape.
- 5.2 The adhesion of the heat-sealed cover tape shall be 40 \pm 20/ \pm 15grams.
- 5.3 Both the head and the end portion of the taping shall be empty for reel package and SMT auto-pickup machine. And a normal paper tape shall be connected in the head of taping for the operator to handle.



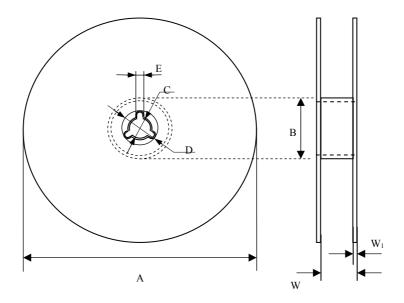
Symbol	A ₀ ±0.05	B ₀ ±0.05	K ₀ ±0.05	D +0.10 -0.05	P ±0.10	P ₂ ±0.10	P ₀ ±0.10	W ±0.10	E ±0.10	F ±0.05
0402	0.62	1.12	0.60	1.55	2.00	2.00	4.00	8.00	1.75	3.50
0603	1.10	1.90	0.95	1.56	4.00	2.00	4.00	8.00	1.75	3.50

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6.Reel Dimension



Symbol	Α	В	ВС		E	W	W ₁
0402	178.0±1.0	60.0±0.5	13.0±0.2	21.0±0.2	2.0±0.5	9.0±0.50	1.5±0.15
0603	178.0±1.0	60.0±0.5	13.0±0.2	21.0±0.2	2.0±0.5	9.0±0.50	1.5±0.15
0805	178.0±1.0	60.0±0.5	13.0±0.2	21.0±0.2	2.0±0.5	9.0±0.50	1.5±0.15
1206	178.0±1.0	60.0±0.5	13.0±0.2	21.0±0.2	2.0±0.5	9.0±0.50	1.5±0.15
1210	178.0±1.0	60.0±0.5	13.0±0.2	21.0±0.2	2.0±0.5	9.0±0.50	1.5±0.15
1812	178.0±1.0	60.0±0.5	13.5±0.1	21.0±0.2	2.0±0.5	13.6±0.2	1.5±0.15
2220	178.0±1.0	60.0±0.5	13.5±0.1	21.0±0.2	2.0±0.5	13.6±0.2	1.5±0.15

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